AMENDMENTS TO THE CLAIMS

Cancel claims 1-10 and 18-27 without prejudice.

This listing of claims will replace all prior versions, and listings, of claims in the application:

- 1-10. (canceled)
- 11. (currently amended) A method comprising:

forming a first metal layer on a first dielectric layer; and

forming a second dielectric layer on the first metal layer;

forming a second metal layer on the second dielectric layer;

patterning the second metal layer such that signal traces are formed in the second metal layer;

patterning the <u>first</u> metal layer being patterned as a substantially continuous sheet having slots formed therein <u>in a substantially rectangular pattern</u> to allow the first and second dielectric layers to adhere to each other by way of the slots; <u>and</u>

adjusting an orientation of at least some of the slots in the substantially rectangular pattern such that none of the signal traces passes over any of the slots.

- 12. (original) The method of claim 11, wherein each of the slots has a length: width ratio of at least 5:1.
- 13. (original) The method of claim 12, wherein the length: width ratio of each slot is at least 10:1.
- 14. (original) The method of claim 11, wherein the slots are arrayed substantially in a facecentered rectangular pattern.

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15. (original) The method of claim 14, wherein rectangular cells of the pattern have an aspect ratio of substantially 1.73:1.

16. (original) The method of claim 11, wherein a first one of the slots has an orientation that is at an angle relative to an orientation of a second one of the slots.

17. (original) The method of claim 11, wherein each of the slots has a width dimension of substantially 50 microns.

18-27. (canceled)